### 2SA2068

FOR LOW FREQUENCY AMPLIFY APPLICATION SILICON PNP EPITAXIAL TYPE

### **DESCRIPTION**

2SA2068 is a super mini package resin sealed silicon PNP epitaxial transistor,

It is designed for low frequency application.

Since it is a super-thin flat lead type package, a high-density mounting are possible.

Complementary with 2SA1235A.

### **FEATURE**

- Super-thin flat lead type package. t=0.45mm
- Excellent linearly of DC forward current gain.
- Low collector to emitter saturation voltage VCE(sat)=-0.3V max (@Ic=-100mA/IB=-10mA)

### **APPLICATION**

For hybrid IC,small type machine low frequency voltage amplify application.

### MAXIMUM RATINGS (Ta=25°C)

Symbol	Parameter	Ratings	Unit
$V_{CBO}$	Collector to Base voltage	-50	٧
$V_{EBO}$	Emitter to Base voltage	-6	٧
V <sub>CEO</sub>	Collector to Emitter voltage	-50	٧
I o	Collector current	-200	mA
P <sub>c</sub>	Collector dissipation	100	mW
T <sub>j</sub>	Junction temperature	+125	°C
$T_{stg}$	Storage temperature	-55 <b>~</b> +125	°C

# JEITA:-, JEDEC:ISAHAYA:TERMINAL CONNECTER ①:BASE ②:EMITTER ③:COLLECTOR

### ELECTRICAL CHARACTERISTICS (Ta=25°C)

Parameter	Symbol	Test conditions	Limits			Unit
Parameter	Symbol	lest conditions		Тур	Max	Unit
Collector to Emitter Breakdown voltage	V(BR)ceo	$I_c=-100 \mu$ A, R <sub>BE</sub> = $\infty$	-50	_	_	V
Collector cut off current	ICBO	$V_{CB}$ =-50V, $I_{E}$ =0mA	-	-	-0.1	μΑ
Emitter cut off current	IEBO	$V_{EB}$ =-6V, I $_{C}$ =0mA	-	-	-0.1	μΑ
DC forward current gain	hFE	V <sub>CE</sub> =-6V, I <sub>C</sub> =-1mA	150	*	800	-
DC forward current gain	hFE	V <sub>CE</sub> =-6V, I <sub>C</sub> =-0.1mA	90	-	-	ı
C to E saturation voltage	VCE(sat)	I <sub>C</sub> =-100mA, I <sub>B</sub> =-10mA	-	-	- 0.3	٧
Gain bandwidth product	fT	V <sub>CE</sub> =-6V, I <sub>E</sub> =10mA	-	200	-	MHz
Collector output capacitance	Cob	$V_{CB}$ =-6V, $I_{E}$ =0mA,f=1MHz	-	4.0	-	pF
Noise figure	NF	V <sub>CE</sub> =-6V, I <sub>E</sub> =0.3mA,f=100Hz,RG=10k $\Omega$	-	-	20	dB

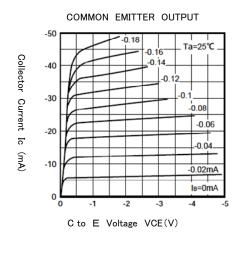
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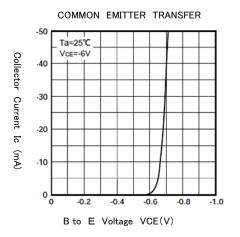
Item	Е	F	G
hFE	150~300	250~500	400~800
Abbrivation	ME	MF	MG

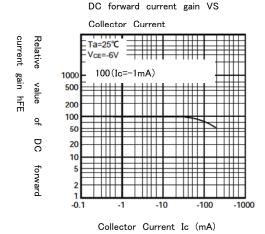
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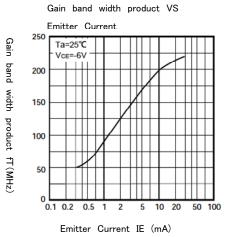
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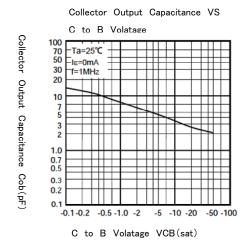
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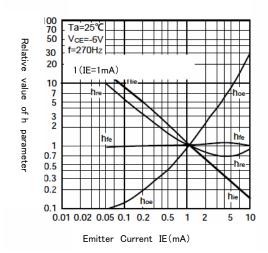


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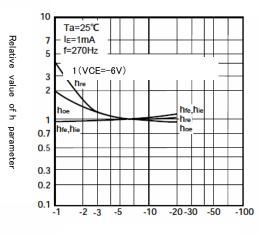
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# FOR LOW FREQUENCY AMPLIFY APPLICATION SILICON PNP EPITAXIAL TYPE

h parameter VS Emitter Current



h parameter VS C to E Voltage



C to E Voltage VCE(V)

### COMMON EMITTER h PARAMETER (typical value)

Symbol	Parameter	Test condition	Limits	Unit
hie	Closed loop small signal input impedance		7.0	kΩ
hre	Open loop small signal reverse voltage amplification factor	Ta=25°C VCE=-6V	0.1	× 10⁻³
hfe	Closed loop small signal forward current amplification factor	f=270Hz		_
hoe	Open loop small signal output admittance			μs



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